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## AP331AWG-7-MS

Product specification





#### **GENERAL DESCRIPTION**

The AP331AWG-7-MS is a voltage comparator usedinintegrated circuit. It provides lower offset voltage, higher pow er supply voltage capability, lower power supply current, lower propagation delay, wider temperature range and higher ESD performance.

The chip supports single power and duel power supply. For duel power supply, the supply voltage ranges from ±1.5V to ±16V, and the VS is at least 1.5V higher than the input common-mode voltage. The output is compatible with TTL and CMOS, and the drain current is not affected by the power supply voltage. The output can be connected to other drain open circuit output to achieve the wired-and" relationship. The AP331AWG-7-MS are available in Green SOT23-5. It operates over an ambient temperature range of -25°C to +85°C.

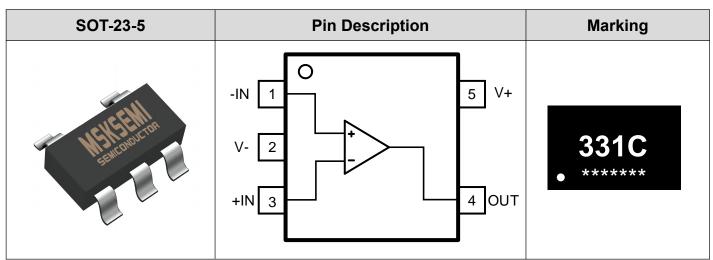
### **Features**

- Wide Supply Range: 3V to 32V
- Low Inuput Offset: 2mV (Typ)
- LowQuiescent Current:
   75µA at Vs=5V
- Low Input Bias Current: 100nA
- Input Common-Mode Voltage Range
- Includes Ground
- Open-Drain Output
- Short Response Time
- SIZE PACKAGES: SOT23-5

## **Applications**

- Hysteresis Comparators
- Floor mopping robot
- One-way UPS
- Server PSU
- Cordless power tool
- Industrial Automation and Control
- Motor driver
- Instruments and apparatus

## **Pin Description AND MARKING**



Pin Name	Pin Number SOT23-5	I/O	Description
-IN	1	I	Inverting input
V-	2	_	Negative(lowest) power supply
+IN	3	I	Noninverting input
OUT	4	0	Output
V+	5	_	Positive (highest) power supply



## Package/Order Information

ORDERING NUMBER	Op Temp(℃)	Package	Packing Option
AP331AWG-7-MS	-25°C~85°C	SOT23-5	3000PCS

## Absolute Maximum Ratings(1)

		MIN	MAX	UNIT
	Supply, V <sub>s</sub> =(V+) - (V-)		36	V
Voltage	Input pin (IN+, IN-) (2)	(V-) - 0.3	(V+) + 0.3	V
	Signal output pin <sup>(3)</sup>	(V-) - 0.3	(V+) + 0.3	V
Commont.	Signal Input pin (IN+, IN-) (2)	-10	10	mA
Current	Signal output pin (3)	-55	55	mA
	Operating Range	-25	85	Ĵ
Temperature	Storage	-65	150	Ĵ
	Junction		150	°C

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
- (2) Output terminals are diode-clamped to the power-supply rails. Output signals that can swing more than 0.5V beyond the supply rails should be current-limited to  $\pm 55$  mA or less.
- (3) Short-circuit from output to Vcc can cause excessive heating and eventual destruction.

## **ESD Ratings**

			VALUE	UNIT
V <sub>(ESD)</sub>	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins (1)	±2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	±1000	V

- (1) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process.

## **Recommended Operating Conditions**

		MIN	MAX	UNIT
Supply voltage, Vs= (V+) - (V-)	Single-supply	3	32	V
	Dual-supply	±1.5	±16	V



## **SIMPLIFIED SCHEMATIC**

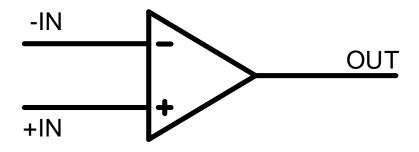


Figure 1. Simplified Schematic

## **ELECTRICAL CHARACTERISTICS**

At  $T_A = 25^{\circ}C$ ,  $V_S = +5V V_{IN+} = V_S$ ,  $V_{IN-} = 1.4V$ ,  $R_{PU} = 10k\Omega$ , unless otherwise noted.

Symbol	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
POWER S	UPPLY					
Vs	Operating Voltage Range		3		32	V
	Quiescent Current	Vs=5V		75		μΑ
la	/per channel	Vs=36V		110		μA
INPUT CH	ARACTERISTICS				1	
Vos	Input offset voltage			2	10	mV
lв	Input Bias Current	V <sub>CM</sub> =V <sub>S</sub> /2		1		nA
los	Input Offset Current			1		nA
V <sub>СМ</sub>	Common-Mode Voltage Range		V <sub>s</sub> -		V <sub>s+</sub> -1.5	V
$A_{\text{VD}}$	Large-signal Differential- voltage Amplification	$V_{S} = 15 \text{ V},$ $V_{O} = 1.4 \text{ V to } 11.4 \text{ V},$ $R_{L} \ge 15 \text{ k}\Omega \text{ to } V_{S}$	50	200		V/mV
OUTPUT	CHARACTERISTICS					
Іон	High-level Output Current	V <sub>OH</sub> =36V, V <sub>ID</sub> =1V		2	30	nA
l <sub>OL</sub>	Low-level Output Current	V <sub>OL</sub> =1.5V, V <sub>ID</sub> =-1V		30		mA
$V_{OL}$	Low-level Output Voltage	I <sub>OL</sub> =4mA, V <sub>ID</sub> =-1V		270		mV



DYNAMIC CHARACTERISTICS					
<b>t</b> RT	Propagation Delay H To L	$V_S=5V$ , $R_{PU}=5.1k\Omega$ , Overdrive =10mV	485		
		$V_s$ =5V , $R_{PU}$ =5.1k $\Omega$ , Overdrive =100mV	400		
	Propagation Delay L To H	$V_S=5V$ , $R_{PU}=5.1k\Omega$ , Overdrive =10mV	360	ns	
		$V_S=5V$ , $R_{PU}=5.1k\Omega$ , Overdrive =100mV	90		

#### **DETAILED DESCRIPTION**

#### Overview

The AP331AWG-7-MS family of comparators can operate up to 36V on the supply pin. This standard device has proven ubiquity and versatility across a wide range of applications. This is due to its low power and high speed. The open-drain output allows the user to configure the output's logic low voltage ( $V_{OL}$ ) and can be utilized to enable the comparator to be used in AND functionality.

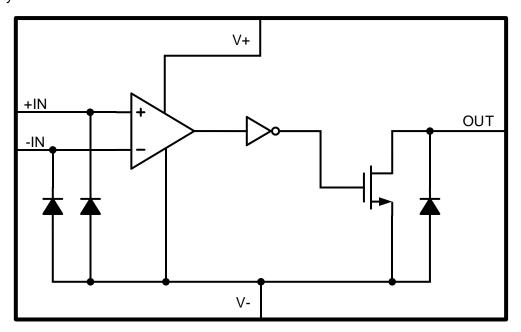


Figure 2. Functional Block Diagram



#### **APPLICATION and IMPLEMENTATION**

#### **Application Information**

The AP331AWG-7-MS will typically be used to compare a single signal to a reference or two signals against each other. Many users take advantage of the open drain output (logic high with pull-up) to drive the comparison logic output to a logic voltage level to an MCU or logic device.

#### **Typical Application**

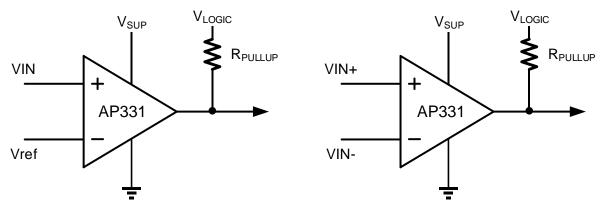


Figure 3. Typical Application Schematic

#### **Power Supply Recommendations**

For fast response and comparison applications with noisy or AC inputs, it is recommended to use a bypass capacitor on the supply pin to reject any variation on the supply voltage. This variation causes temporary fluctuations in the comparator's input common mode range and create an inaccurate comparison.

## Layout

#### **Layout Guidelines**

For accurate comparator applications without hysteresis it is important maintain a stable power supply with minimized noise and glitches, which can affect the high-level input common mode voltage range. In order to achieve this, it is best to add a bypass capacitor between the supply voltage and ground. This should be implemented on the positive power supply and negative supply (if available). If a negative supply is not being used, do not put a capacitor between the IC's GND pin and system ground.

#### **Layout Example**

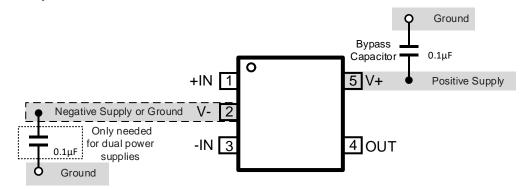
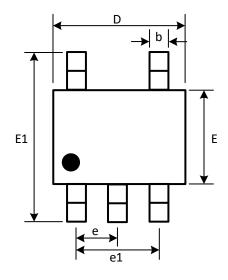


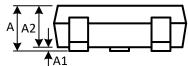
Figure 4. AP331AWG-7-MS Layout Example

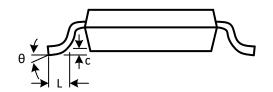


## **PACKAGE DESCRIPTION**

#### SOT23-5







(Unit: mm)

Symbol	Min	Max
А	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.300	0.500
С	0.100	0.200
D	2.820	3.020
е	0.950	(BSC)
e1	1.800	2.000
Е	1.500	1.700
E1	2.650	2.950
L	0.300	0.600
θ	0°	8°



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